

# NPIC6C596

Power logic 8-bit shift register; open-drain outputs

Rev. 2 — 4 July 2013

Product data sheet

## 1. General description

The NPIC6C596 is an 8-bit serial-in/serial or parallel-out shift register with a storage register and open-drain outputs. Both the shift and storage register have separate clocks. The device features a serial input (DS) and a serial output (Q7S) to enable cascading and an asynchronous reset  $\overline{MR}$  input. A LOW on  $\overline{MR}$  resets both the shift register and storage register. Data is shifted on the LOW-to-HIGH transitions of the SHCP input. The data in the shift register is transferred to the storage register on a LOW-to-HIGH transition of the STCP input. If both clocks are connected together, the shift register is always one clock pulse ahead of the storage register. To provide additional hold time in cascaded applications, the serial output QS7 is clocked out on the falling edge of SHCP. Data in the storage register drives the gate of the output extended-drain NMOS (EDNMOS) transistor whenever the output enable input ( $\overline{OE}$ ) is LOW. A HIGH on  $\overline{OE}$  causes the outputs to assume a high-impedance OFF-state. Operation of the  $\overline{OE}$  input does not affect the state of the registers.

The open-drain outputs are 33 V/100 mA continuous current extended-drain NMOS transistors designed for use in systems that require moderate load power such as LEDs. Integrated voltage clamps in the outputs provide protection against inductive transients making the device suitable for power driver applications such as relays, solenoids and other low-current or medium-voltage loads.

## 2. Features and benefits

- Specified from  $-40\text{ }^{\circ}\text{C}$  to  $+125\text{ }^{\circ}\text{C}$
- Low  $R_{DSon}$
- Eight Power EDNMOS transistor outputs of 100 mA continuous current
- 250 mA current limit capability
- Output clamping voltage 33 V
- 30 mJ avalanche energy capability
- Enhanced cascading for multiple stages
- All registers cleared with single input
- Low power consumption
- ESD protection:
  - ◆ HBM JDS-001 Class 2 exceeds 2500 V
  - ◆ CDM JESD22-C101E exceeds 1000 V

3. Applications

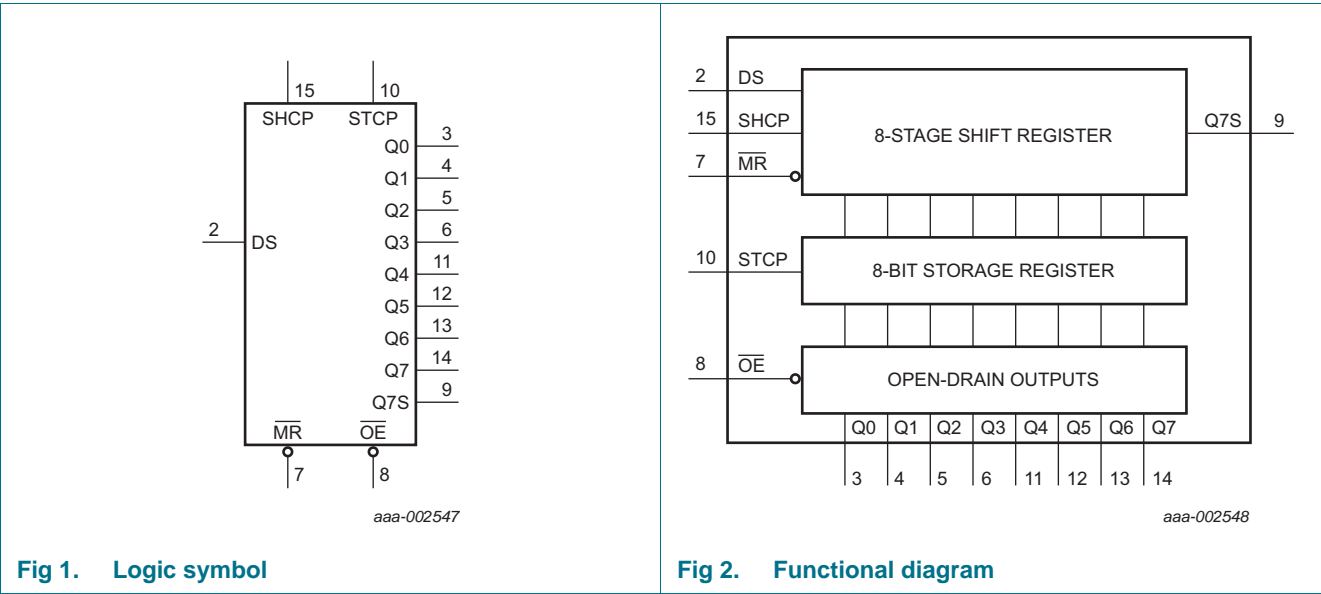
- LED sign
- Graphic status panel
- Fault status indicator

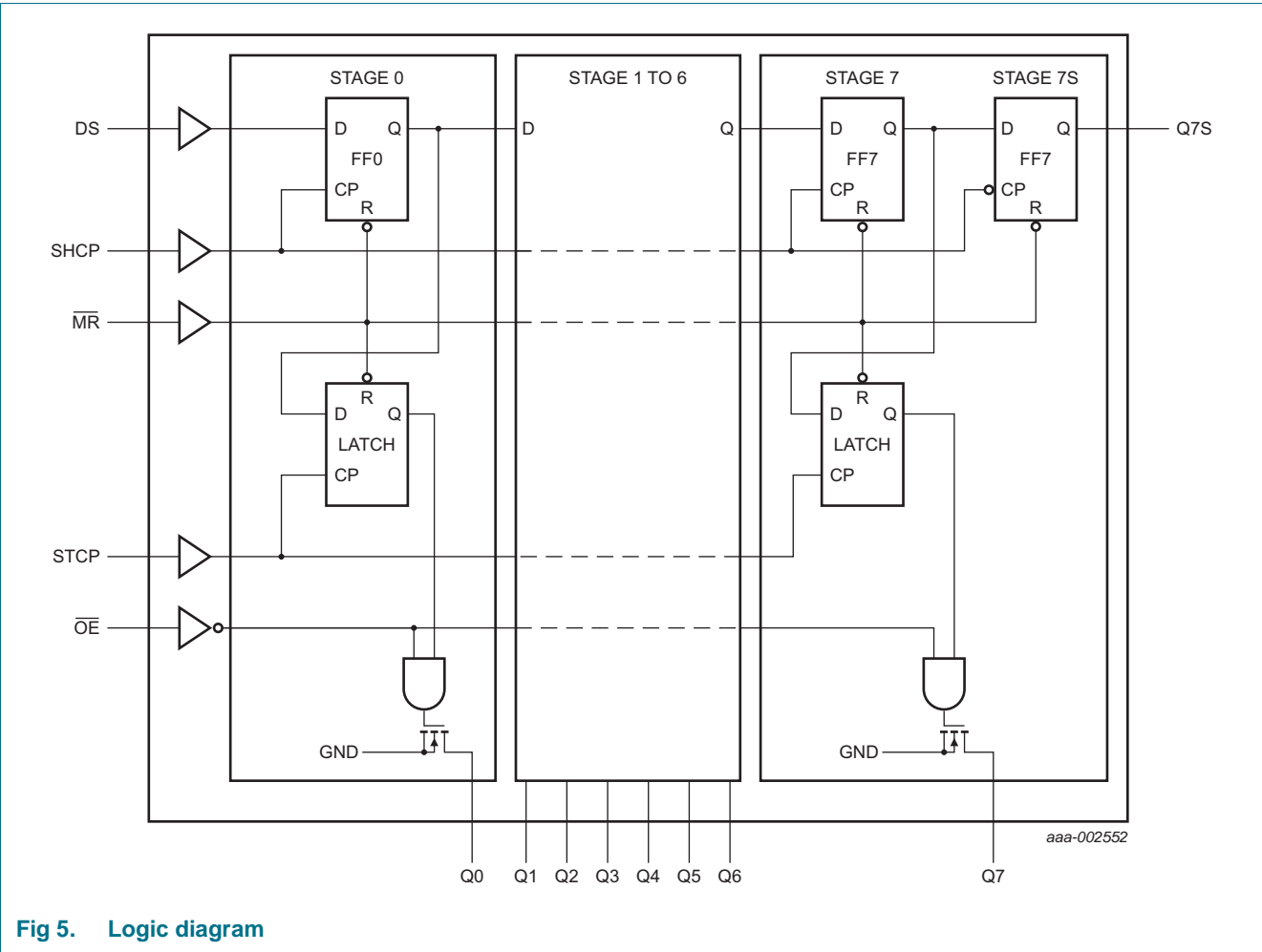
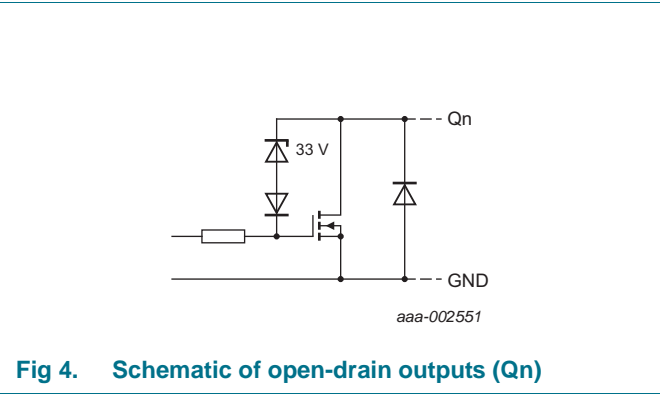
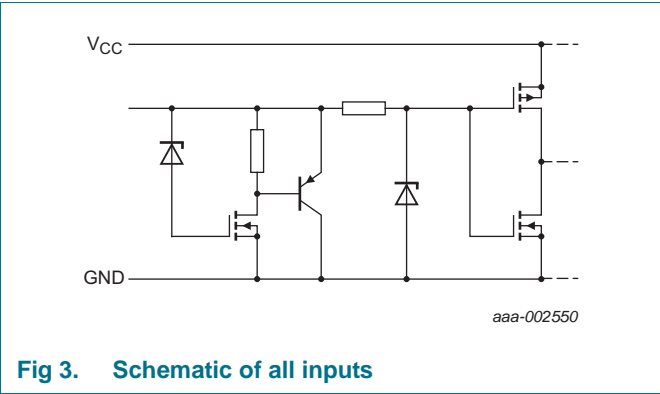
4. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
NPIC6C596D	−40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1
NPIC6C596PW	−40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1
NPIC6C596BQ	−40 °C to +125 °C	DHVQFN16	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 × 3.5 × 0.85 mm	SOT763-1

5. Functional diagram





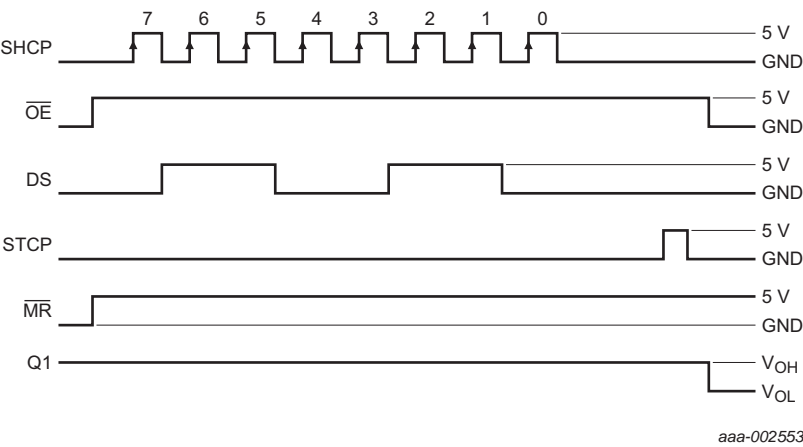
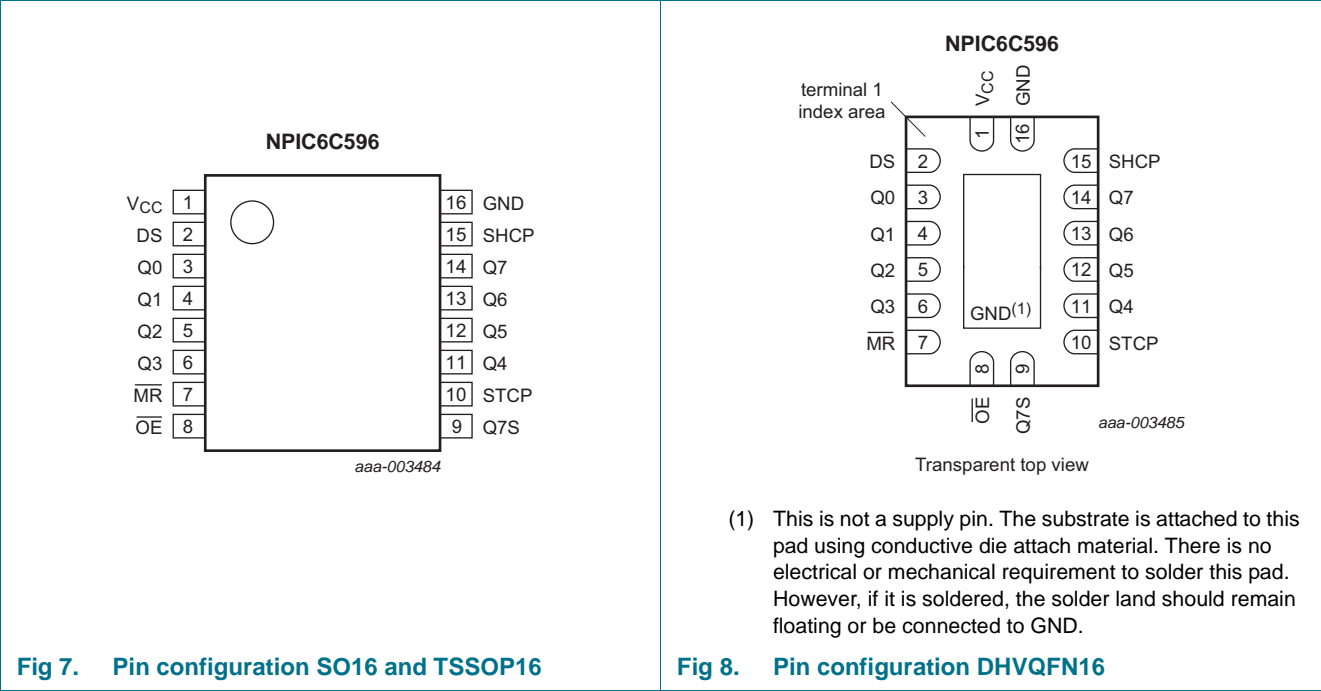


Fig 6. Timing diagram

6. Pinning information

6.1 Pinning



6.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
V <sub>CC</sub>	1	supply voltage
DS	2	serial data input
Q0, Q1, Q2, Q3, Q4, Q5, Q6, Q7	3, 4, 5, 6, 11, 12, 13, 14	parallel data output (open-drain)
MR	7	master reset (active LOW)
OE	8	output enable input (active LOW)
Q7S	9	serial data output
STCP	10	storage register clock input
SHCP	15	shift register clock input
GND	16	ground (0 V)

## 7. Limiting values

**Table 3. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+7.0	V
$V_I$	input voltage		-0.3	+7.0	V
$V_{DS}$	drain-source voltage	power EDNMOS drain-source voltage <a href="#">[1]</a>	-	+33	V
$I_{d(SD)}$	source-drain diode current	continuous	-	250	mA
		pulsed <a href="#">[2]</a>	-	500	mA
$I_D$	drain current	$T_{amb} = 25\text{ °C}$			
		continuous; each output; all outputs on	-	100	mA
		pulsed; each output; all outputs on <a href="#">[2]</a>	-	250	mA
$I_{DM}$	peak drain current	single output; $T_{amb} = 25\text{ °C}$ <a href="#">[2]</a>	-	250	mA
$E_{AS}$	avalanche energy	single pulse; see <a href="#">Figure 9</a> <a href="#">[3]</a>	-	30	mJ
$I_{AL}$	avalanche current	see <a href="#">Figure 9</a> <a href="#">[3]</a>	-	200	mA
$T_{stg}$	storage temperature		-65	+150	°C
$P_{tot}$	total power dissipation	$T_{amb} = 25\text{ °C}$ <a href="#">[4]</a>			
		SO16	-	800	mW
		TSSOP16	-	725	mW
		DHVQFN16	-	1825	mW
		$T_{amb} = 125\text{ °C}$ <a href="#">[4]</a>			
		SO16	-	160	mW
		TSSOP16	-	145	mW
		DHVQFN16	-	365	mW

[1] Each power EDNMOS source is internally connected to GND.

[2] Pulse duration  $\leq 100\text{ }\mu\text{s}$  and duty cycle  $\leq 2\%$ .

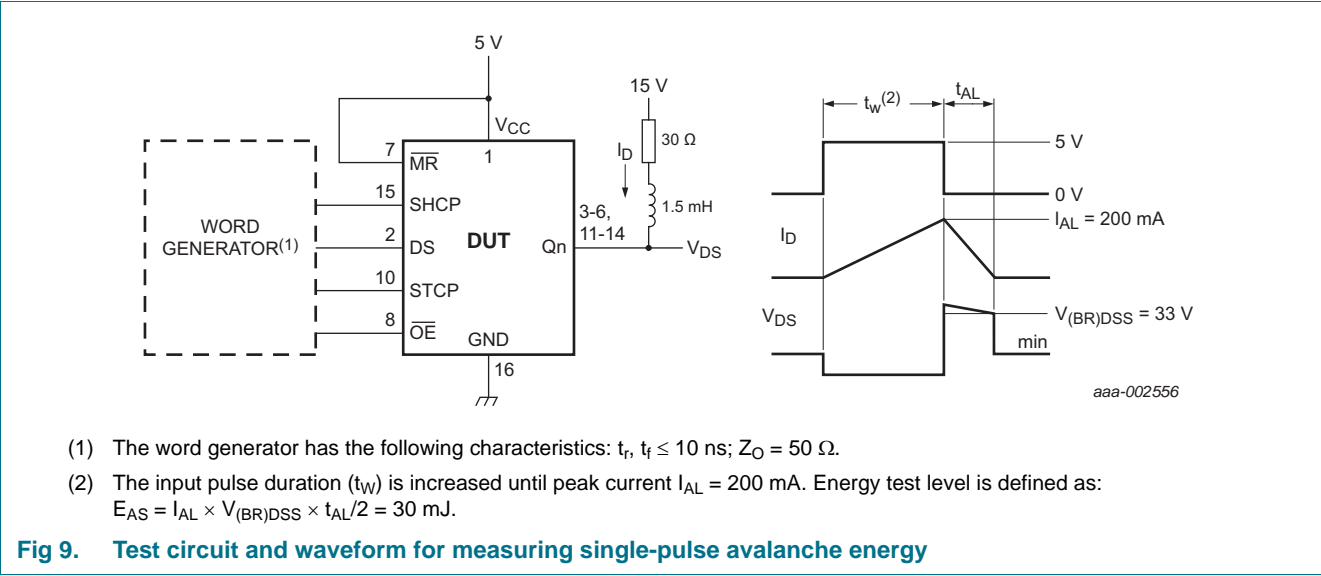
[3]  $V_{DS} = 15\text{ V}$ ; starting junction temperature ( $T_j$ ) =  $25\text{ °C}$ ;  $L = 1.5\text{ H}$ ; avalanche current ( $I_{AL}$ ) =  $200\text{ mA}$ .

[4] For SO16 packages: above  $25\text{ °C}$  the value of  $P_{tot}$  derates linearly with  $6.4\text{ mW/°C}$ .

For TSSOP16 packages: above  $25\text{ °C}$  the value of  $P_{tot}$  derates linearly with  $5.8\text{ mW/°C}$ .

For DHVQFN16 packages: above  $25\text{ °C}$  the value of  $P_{tot}$  derates linearly with  $14.6\text{ mW/°C}$ .

7.1 Test circuit and waveform



8. Recommended operating conditions

Table 4. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{CC}$	supply voltage		4.5	-	5.5	V
$V_I$	input voltage		0	-	5.5	V
$I_D$	drain current	pulsed drain output current; $V_{CC} = 5 \text{ V}$ ; $T_{amb} = 25 \text{ }^\circ\text{C}$ ; all outputs on	[1][2] -	-	250	mA
$T_{amb}$	ambient temperature		-40	-	+125	$^\circ\text{C}$

- [1] Pulse duration  $\leq 100 \mu\text{s}$  and duty cycle  $\leq 2 \%$ .
- [2] Technique should limit  $T_j - T_{amb}$  to  $10 \text{ }^\circ\text{C}$  maximum.

9. Static characteristics

Table 5. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	$V_{CC} = 5.0 \text{ V}$ ; $T_{amb} = 25 \text{ }^\circ\text{C}$			Unit
			Min	Typ	Max	
$V_{IH}$	HIGH-level input voltage	$V_{CC} = 4.5 \text{ V}$ to $5.5 \text{ V}$	$0.85V_{CC}$	-	-	V
$V_{IL}$	LOW-level input voltage	$V_{CC} = 4.5 \text{ V}$ to $5.5 \text{ V}$	-	-	$0.15V_{CC}$	V
$V_{OH}$	HIGH-level output voltage	serial data output Q7S; $V_I = V_{IH}$ or $V_{IL}$				
		$I_O = -20 \mu\text{A}$ ; $V_{CC} = 4.5 \text{ V}$	4.4	4.49	-	V
		$I_O = -4 \text{ mA}$ ; $V_{CC} = 4.5 \text{ V}$	4.0	4.2	-	V

**Table 5.** Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	$V_{CC} = 5.0\text{ V}; T_{amb} = 25\text{ }^{\circ}\text{C}$			Unit
			Min	Typ	Max	
$V_{OL}$	LOW-level output voltage	serial data output Q7S; $V_I = V_{IH}$ or $V_{IL}$				
		$I_O = 20\text{ }\mu\text{A}; V_{CC} = 4.5\text{ V}$	-	0.005	0.1	V
		$I_O = 4\text{ mA}; V_{CC} = 4.5\text{ V}$	-	0.3	0.5	V
$I_{IH}$	HIGH-level input current	$V_{CC} = 5.5\text{ V}; V_I = V_{CC}$	-	-	1	$\mu\text{A}$
$I_{IL}$	LOW-level input current	$V_{CC} = 5.5\text{ V}; V_I = 0\text{ V}$	-1	-	-	$\mu\text{A}$
$V_{(BR)DSS}$	drain-source breakdown voltage	$I_D = 1\text{ mA}$	33	37	-	V
$V_{SD}$	source-drain voltage	diode forward voltage; $I_F = 100\text{ mA}$	-	0.85	1.2	V
$I_{CC}$	supply current	logic supply current; $V_{CC} = 5.5\text{ V}; V_I = V_{CC}$ or GND				
		all outputs off	-	0.004	200	$\mu\text{A}$
		all outputs on <a href="#">[1]</a>	-	0.006	500	$\mu\text{A}$
		all outputs off; SHCP = 5 MHz; $C_L = 30\text{ pF}$ ; see <a href="#">Figure 14</a> and <a href="#">Figure 16</a>	-	0.75	5	mA
$I_{O(nom)}$	nominal output current	$V_{DS} = 0.5\text{ V}; T_{amb} = 85\text{ }^{\circ}\text{C}; I_{out} = I_D$ <a href="#">[2][3][4]</a>	-	140	-	mA
$I_{DSX}$	drain cut-off current	$V_{CC} = 5.5\text{ V}; V_{DS} = 30\text{ V}$	-	0.002	0.2	$\mu\text{A}$
		$V_{CC} = 5.5\text{ V}; V_{DS} = 30\text{ V}; T_{amb} = 125\text{ }^{\circ}\text{C}$	-	0.15	0.3	$\mu\text{A}$
$R_{DSon}$	drain-source on-state resistance	see <a href="#">Figure 17</a> and <a href="#">Figure 18</a> <a href="#">[2][3]</a>				
		$V_{CC} = 4.5\text{ V}; I_D = 50\text{ mA}$	-	3.0	9	$\Omega$
		$V_{CC} = 4.5\text{ V}; I_D = 50\text{ mA}; T_{amb} = 125\text{ }^{\circ}\text{C}$		5.4	12	$\Omega$
		$V_{CC} = 4.5\text{ V}; I_D = 100\text{ mA}$	-	3.1	10	$\Omega$

[1] Output currents below 250 mA current limit.

[2] Technique should limit  $T_j - T_{amb}$  to 10  $^{\circ}\text{C}$  maximum.

[3] These parameters are measured with voltage-sensing contacts separate from the current-carrying contacts.

[4] Nominal output current is defined for a consistent comparison between devices from different sources. It is the current that produces a voltage drop of 0.5 V at  $T_{amb} = 85\text{ }^{\circ}\text{C}$ .



## 10. Dynamic characteristics

**Table 6. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V); For test circuit see [Figure 14](#).

Symbol	Parameter	Conditions	$V_{CC} = 5.0\text{ V}; T_{amb} = 25\text{ }^{\circ}\text{C}$			Unit
			Min	Typ	Max	
$t_{PLH}$	LOW to HIGH propagation delay	$\overline{OE}$ to Qn; $I_D = 75\text{ mA}$ ; see <a href="#">Figure 10</a> and <a href="#">Figure 19</a>	-	97	-	ns
$t_{PHL}$	HIGH to LOW propagation delay	$\overline{OE}$ to Qn; $I_D = 75\text{ mA}$ ; see <a href="#">Figure 10</a> and <a href="#">Figure 19</a>	-	9	-	ns
$t_r$	rise time	$\overline{OE}$ to Qn; $I_D = 75\text{ mA}$ ; see <a href="#">Figure 10</a> and <a href="#">Figure 19</a>	-	60	-	ns
$t_f$	fall time	$\overline{OE}$ to Qn; $I_D = 75\text{ mA}$ ; see <a href="#">Figure 10</a> and <a href="#">Figure 19</a>	-	18	-	ns
$t_{pd}$	propagation delay	SHCP to Q7S; $I_D = 75\text{ mA}$ ; see <a href="#">Figure 11</a> <a href="#">[1]</a>	-	5	-	ns
$f_{max}$	maximum frequency	SHCP; $I_D = 75\text{ mA}$ ; see <a href="#">Figure 11</a> <a href="#">[2]</a>	-	-	10	MHz
$t_{rr}$	reverse recovery time	$I_F = 100\text{ mA}$ ; $dI/dt = 10\text{ A}/\mu\text{s}$ ; see <a href="#">Figure 13</a> <a href="#">[3][4]</a>	-	120	-	ns
$t_a$	reverse recovery current rise time	$I_F = 100\text{ mA}$ ; $dI/dt = 10\text{ A}/\mu\text{s}$ ; see <a href="#">Figure 13</a> <a href="#">[3][4]</a>	-	100	-	ns
$t_{su}$	set-up time	DS to SHCP; see <a href="#">Figure 12</a>	15	-	-	ns
$t_h$	hold time	DS to SHCP; see <a href="#">Figure 12</a>	15	-	-	ns
$t_W$	pulse width		40	-	-	ns

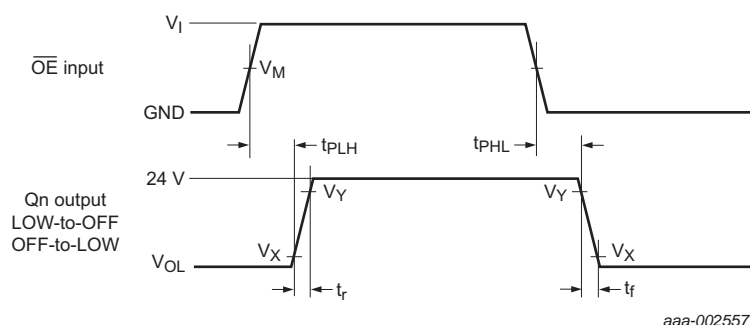
[1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

[2] This is the maximum serial clock frequency assuming cascaded operation where serial data is passed from one stage to a second stage. The clock period allows for SHCP → Q7S propagation delay and setup time plus some timing margin.

[3] Technique should limit  $T_j - T_{amb}$  to 10 °C maximum.

[4] These parameters are measured with voltage-sensing contacts separate from the current-carrying contacts.

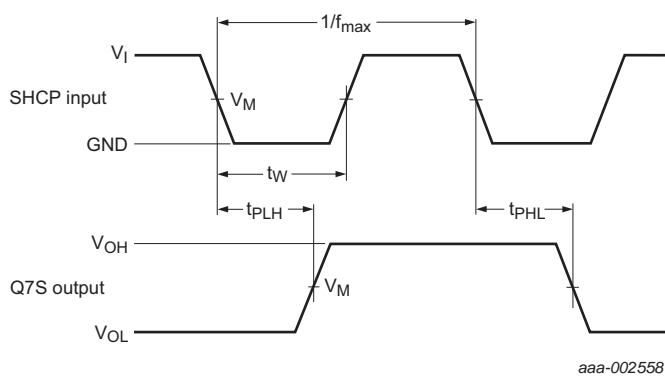
### 10.1 Test circuits and waveforms



Measurement points are given in [Table 7](#).

$V_{OL}$  is the typical output voltage level that occurs with the output load.

**Fig 10. The output enable ( $\overline{OE}$ ) input to data output (Qn) propagation delays and (Qn) output rise and fall times**

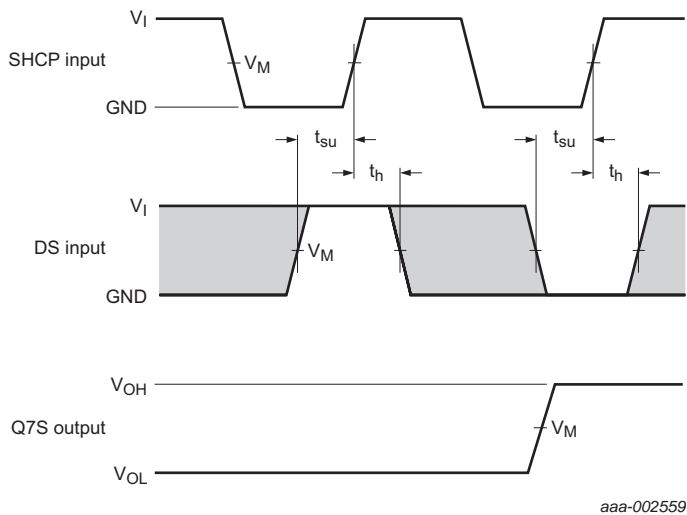


Measurement points are given in [Table 7](#).  
 $V_{OL}$  and  $V_{OH}$  are the typical output voltage levels that occur with the output load.

**Fig 11. The shift clock (SHCP) to serial data output (Q7S) propagation delays with the minimum shift clock pulse width and maximum shift clock frequency**

**Table 7. Measurement points**

Supply voltage	Input	Output		
$V_{CC}$	$V_M$	$V_M$	$V_X$	$V_Y$
5 V	$0.5V_{CC}$	$0.5V_{DS}$	$0.1V_{DS}$	$0.9V_{DS}$

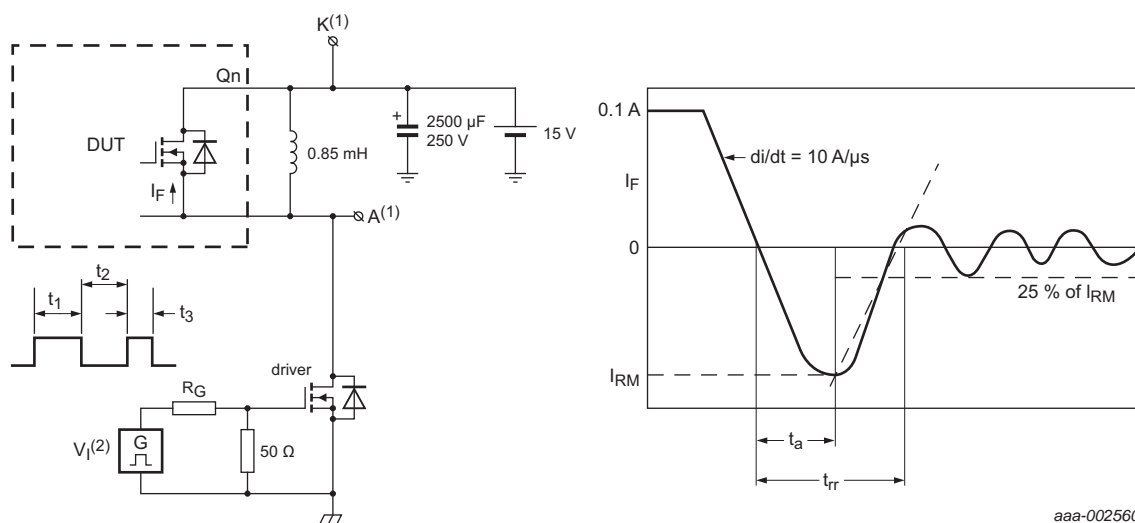


Measurement points are given in [Table 8](#).  
The shaded areas indicate when the input is permitted to change for predictable output performance.  
 $V_{OL}$  and  $V_{OH}$  are the typical output voltage levels that occur with the output load.

**Fig 12. The data set-up and hold times for the serial data input (DS)**

**Table 8. Measurement points**

Supply voltage	Input	Output
$V_{CC}$	$V_M$	$V_M$
5 V	$0.5V_{CC}$	$0.5V_{CC}$



- (1) The open-drain Qn terminal under test is connected to test point K. All other terminals are connected together and connected to test point A.
- (2) The  $V_1$  amplitude and  $R_G$  are adjusted for  $di/dt = 10 \text{ A}/\mu\text{s}$ . A  $V_1$  double-pulse train is used to set  $I_F = 0.1 \text{ A}$ , where  $t_1 = 10 \mu\text{s}$ ,  $t_2 = 7 \mu\text{s}$  and  $t_3 = 3 \mu\text{s}$ .

**Fig 13. Test circuit and waveform for measuring reverse recovery current**

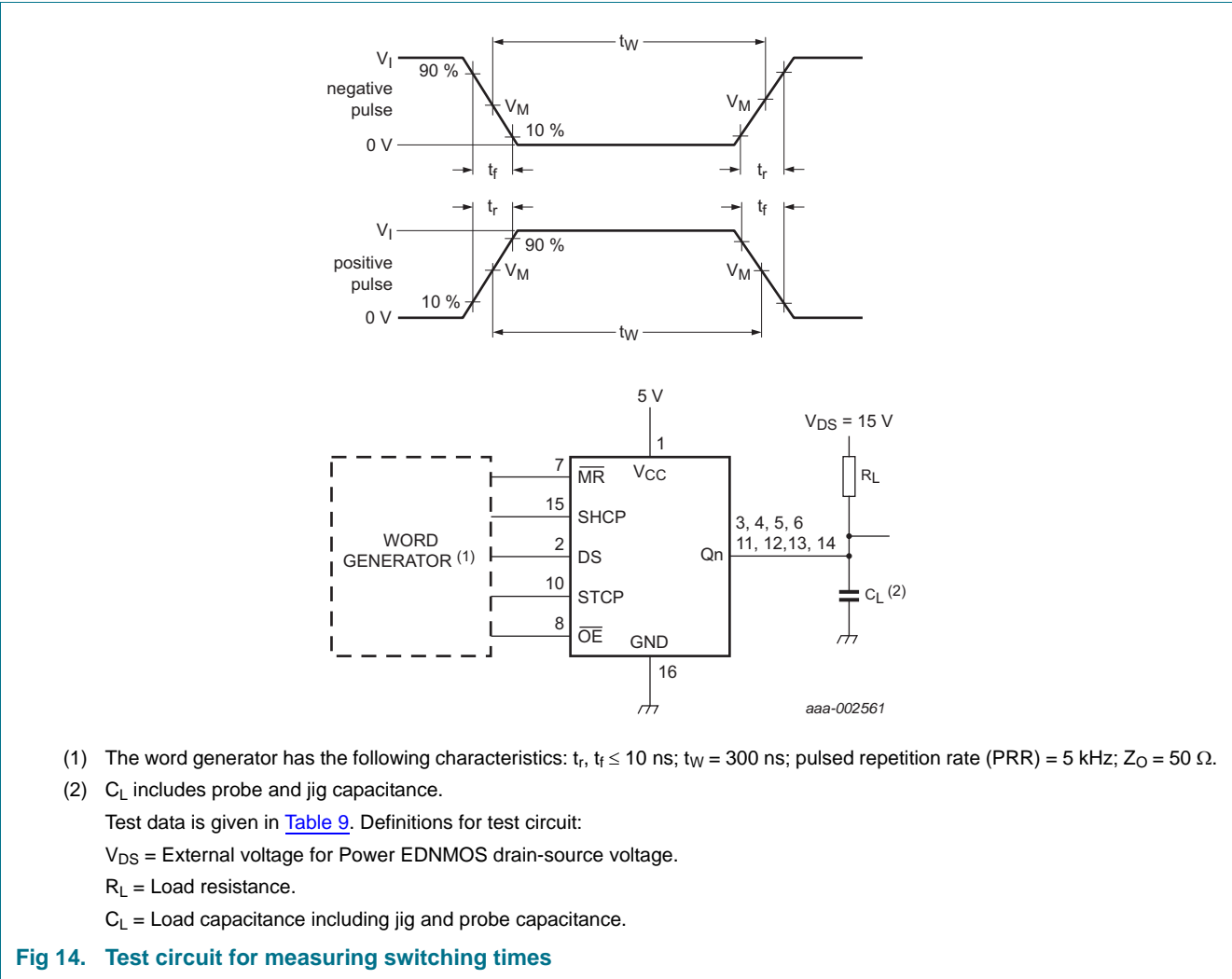
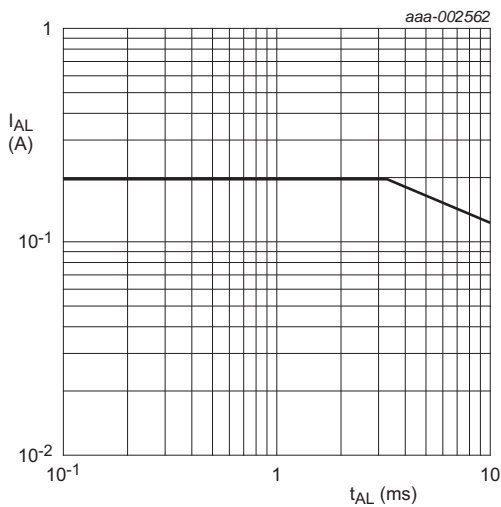


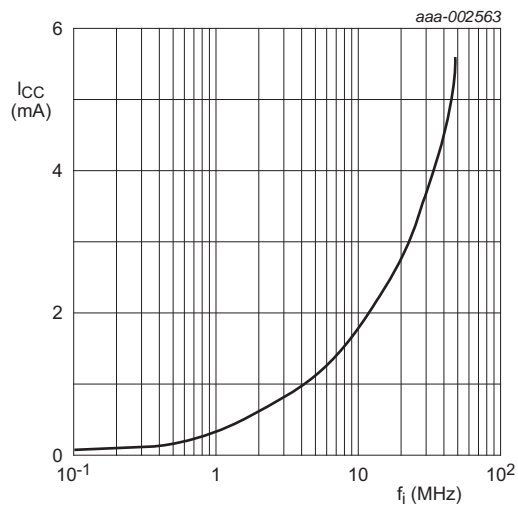
Table 9. Test data

Supply voltage	Input			Load	
	$V_I$	$t_r, t_f$	$V_M$	$C_L$	$R_L$
5 V	5 V	$\leq 10$ ns	50 %	30 pF	200 $\Omega$



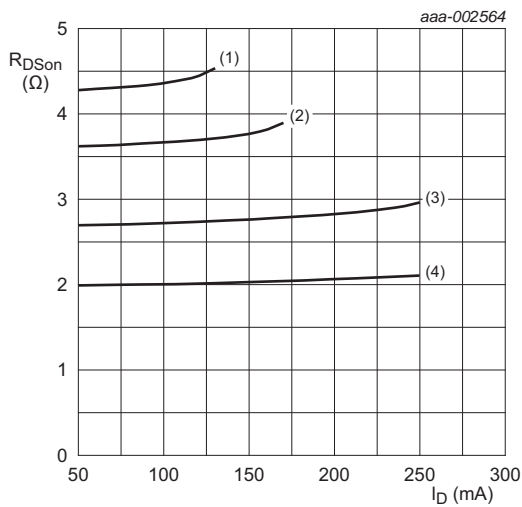
$T_{amb} = 25\text{ }^{\circ}\text{C}$ .

Fig 15. Avalanche current (peak) versus time duration of avalanche



$T_{amb} = -40\text{ }^{\circ}\text{C}$  to  $+125\text{ }^{\circ}\text{C}$ ;  $V_{CC} = 5\text{ V}$ .

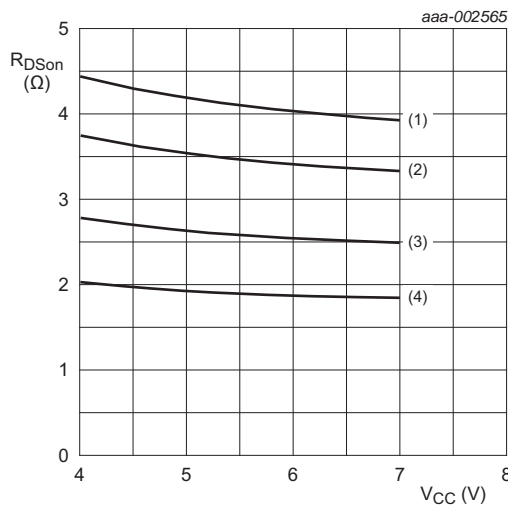
Fig 16. Supply current versus frequency



$V_I = V_{CC}$  or GND and  $V_O = \text{GND or } V_{CC}$ .

- (1)  $T_{amb} = 125\text{ }^{\circ}\text{C}$
- (2)  $T_{amb} = 85\text{ }^{\circ}\text{C}$
- (3)  $T_{amb} = 25\text{ }^{\circ}\text{C}$
- (4)  $T_{amb} = -40\text{ }^{\circ}\text{C}$

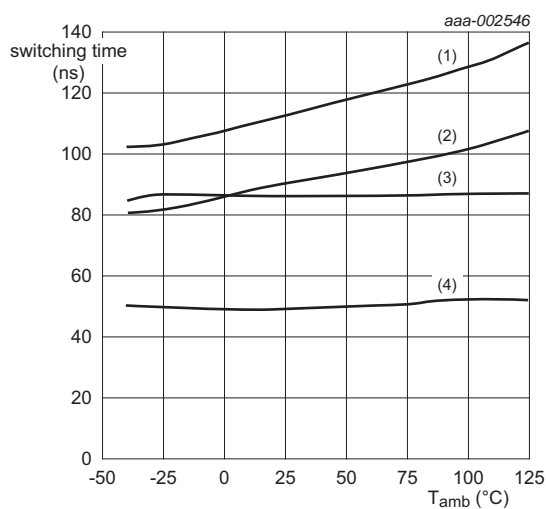
Fig 17. Drain-source on-state resistance versus drain current



$V_I = V_{CC}$  or GND and  $V_O = \text{open circuit}$ .

- (1)  $T_{amb} = 125\text{ }^{\circ}\text{C}$
- (2)  $T_{amb} = 85\text{ }^{\circ}\text{C}$
- (3)  $T_{amb} = 25\text{ }^{\circ}\text{C}$
- (4)  $T_{amb} = -40\text{ }^{\circ}\text{C}$

Fig 18. Static drain-source on-state resistance versus supply voltage



Technique limit  $T_J - T_C$  to 10 °C maximum.

- (1)  $t_{PLH}$ .
- (2)  $t_r$ .
- (3)  $t_f$ .
- (4)  $t_{PHL}$ .

**Fig 19. Switching time versus case temperature**

11. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1

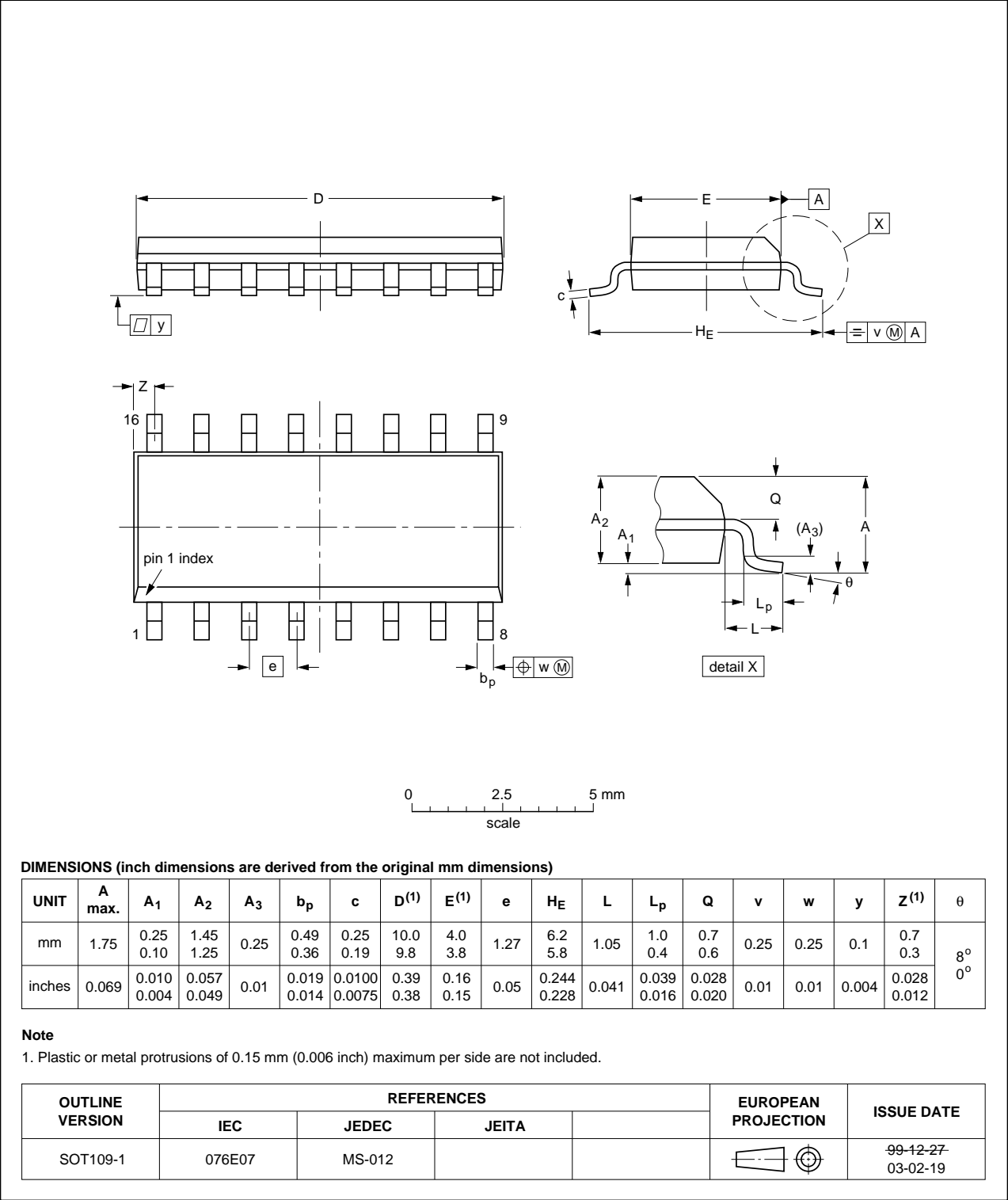


Fig 20. Package outline SOT109-1 (SO16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1

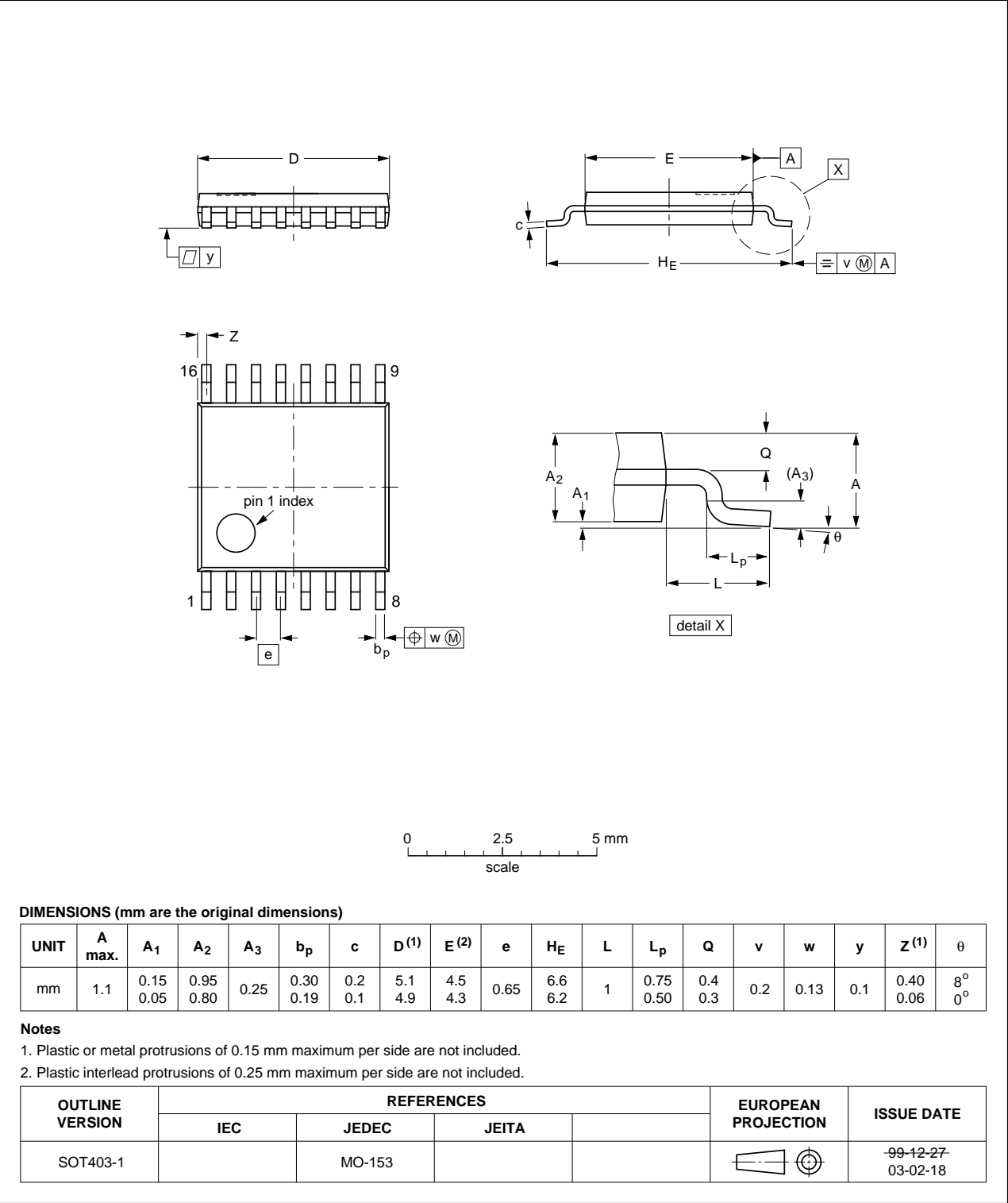


Fig 21. Package outline SOT403-1 (TSSOP16)





## 12. Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
EDNMOS	Extended Drain Negative Metal Oxide Semiconductor
ESD	ElectroStatic Discharge
HBM	Human Body Model
TTL	Transistor-Transistor Logic

## 13. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
NPIC6C596 v.2	20130704	Product data sheet	-	NPIC6C596 v.1
Modifications:	• Figure 5 corrected (errata).			
NPIC6C596 v.1	20120821	Product data sheet	-	-

## 14. Legal information

### 14.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nexperia.com>.

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## 15. Contact information

For more information, please visit: <http://www.nexperia.com>

For sales office addresses, please send an email to: [salesaddresses@nexperia.com](mailto:salesaddresses@nexperia.com)

## 16. Contents

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- Входной контроль качества.
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